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320 #5 1746

Patent  
259/079  
P01-0015

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: ) Group Art Unit: 1746  
)  
KENNY, Michael et al. ) Examiner: Not yet assigned  
)  
Serial No.: 09/925,884 ✓ )  
)  
Filed: August 6, 2001 )  
)  
For: Process And Apparatus For Treating A )  
Workpiece Such As A Semiconductor Wafer )

PRELIMINARY AMENDMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

RECEIVED  
APR 19 2002  
TC 1700

Prior to examination on the merits, please amend the above-identified application as follows.

Cancelled  
1/2/03  
called MR. Ohriner  
on 1/2/03

CERTIFICATE OF MAILING  
(37 C.F.R. §1.8a)

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as First Class Mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

April 9, 2002  
Date of Deposit

*Laura Murphy*  
Person Mailing Paper  
Laura Murphy